



Product Change Notification

Change Notification #: 117885 - 00
Change Title: Intel® Compute Module HNS2600BPBR
Intel® Compute Module HNS2600BPB24R
Intel® Compute Module HNS2600BPSR
Intel® Compute Module HNS2600BPS24R,
PCN 117885-00, Product Design,
Design Tool Improvement for Plastic Air
Duct Cover

Date of Publication: November 18, 2020

Key Characteristics of the Change:

Product Design

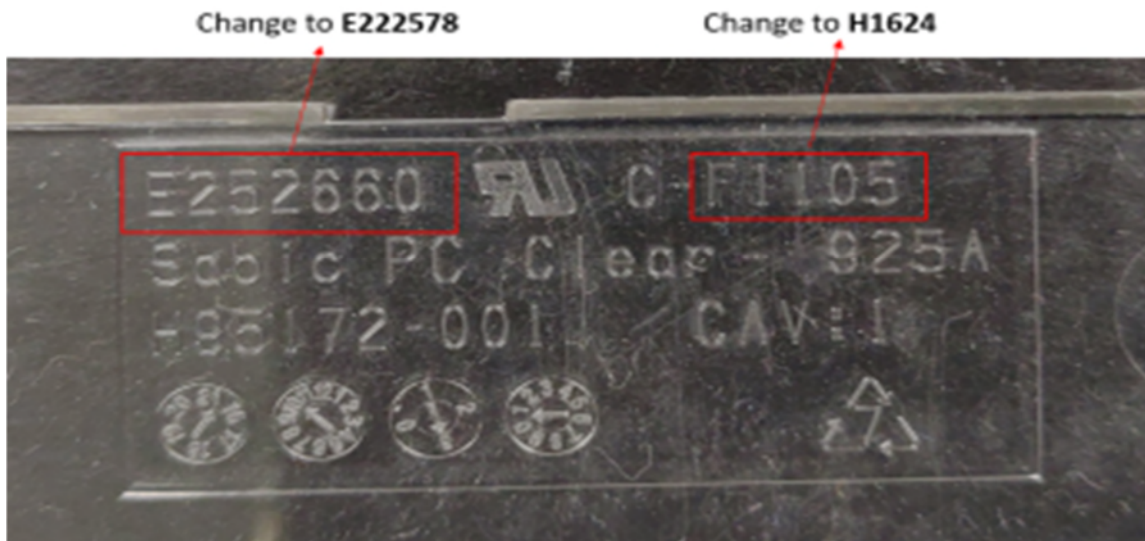
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 7, 2020
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing an improvement on the tool used for manufacturing the plastic air duct cover. The UL numbers will change due to the tool improvement:



Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
HNS2600BPBR	986116	K36253-004	K36253-005
HNS2600BPSR	986117	K36260-003	K36260-004
HNS2600BPB24R	986118	K36256-004	K36256-005
HNS2600BPS24R	986119	K36261-004	K36261-005

PCN Revision History:

Date of Revision:

November 18, 2020

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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